ALUMINUM ELECTROLYTIC CAPACITORS

nichicon

WD

Chip Type, Low Impedance
High Temperature (260°C) Reflow
series

For SMD | Low Impedance | Anti-Solvent Feature

- Corresponding with 260°C peak reflow soldering
  Recomended reflow condition : 260°C peak 5 sec. 230°C over 60 sec.
  2 times (φ10 × 10, : 1 time)
- Chip type, low impedance temperature range up to +105°C.
- Designed for surface mounting on high density PC board.
- Applicable to automatic mounting machine using carrier tape.
- Adapted to the RoHS directive (2002/95/EC).

WD
High Temperature Reflow
UD

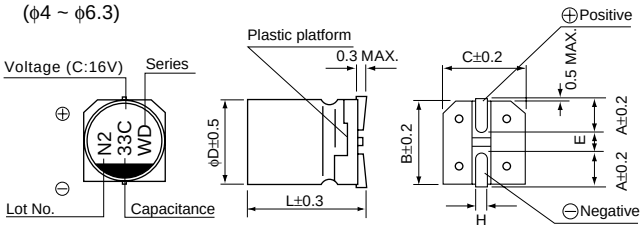


■Specifications

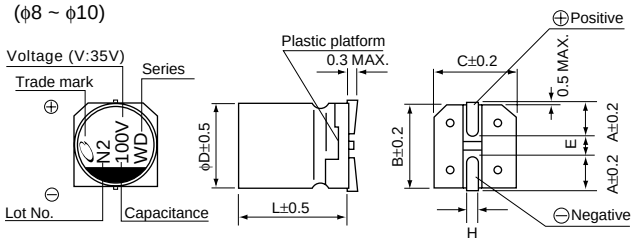
Item	Performance Characteristics
Category Temperature Range	–55 ~ +105°C
Rated Voltage Range	6.3 ~ 50V
Rated Capacitance Range	1 ~ 1500μF
Capacitance Tolerance	±20% at 120Hz, 20°C
Leakage Current	After 2 minutes' application of rated voltage, leakage current is not more than 0.01 CV or 3 (μA), whichever is greater.
tan δ	Measurement frequency : 120Hz, Temperature : 20°C Rated voltage (V): 6.3 / 10 / 16 / 25 / 35 / 50 tan δ (MAX.): 0.26 (0.28) / 0.20 (0.24) / 0.16 (0.20) / 0.14 (0.16) / 0.12 (0.14) / 0.12 (0.14) ( ) is φ8 over
Stability at Low Temperature	Measurement frequency : 120Hz Rated voltage (V): 6.3 / 10 / 16 / 25 / 35 / 50 Impedance ratio ZT / Z20 (MAX.) Z–25°C / Z+20°C: 3 / 2 / 2 / 2 / 2 / 2 Z–55°C / Z+20°C: 5 / 4 / 4 / 3 / 3 / 3
Endurance	After 5000 hours' (2000 hours for φD ≤ 6.3) application of rated voltage at 105°C , capacitors meet the characteristic requirements listed at right. Capacitance change: Within ±30% of initial value tan δ: 200% or less of initial specified value Leakage current: Initial specified value or less
Shelf Life	After storing the capacitors under no load at 105°C for 1000 hours, and after performing voltage treatment based on JIS C 5101-4 clause 4.1 at 20°C, they will meet the specified value for endurance characteristics listed above.
Resistance to soldering heat	The capacitors shall be kept on the hot plate maintained at 250°C for 30 seconds. After removing from the hot plate and restored at room temperature, they meet the characteristic requirements listed at right. Capacitance change: Within ±10% of initial value tan δ: Initial specified value or less Leakage current: Initial specified value or less
Marking	Black print on the case top.

■Chip Type

(φ4 ~ φ6.3)



(φ8 ~ φ10)



Voltage

V	6.3	10	16	25	35	50
Code	j	A	C	E	V	H

● Dimension table in next page.

Type numbering system (Example : 16V 22μF)

1	2	3	4	5	6	7	8	9	10	11	12	13	14
U	W	D	1	C	2	2	0	M	C	L	1	G	S

- Package code
- Configuration
- Capacitance tolerance (±20%)
- Rated Capacitance (22 μF)
- Rated voltage (16V)
- Series name
- Type

(mm)

φD × L	4 × 5.8	5 × 5.8	6.3 × 5.8	6.3 × 7.7	8 × 10	10 × 10
A	1.8	2.1	2.4	2.4	2.9	3.2
B	4.3	5.3	6.6	6.6	8.3	10.3
C	4.3	5.3	6.6	6.6	8.3	10.3
E	1.0	1.3	2.2	2.2	3.1	4.5
L	5.8	5.8	5.8	7.7	10	10
H	0.5 ~ 0.8	0.5 ~ 0.8	0.5 ~ 0.8	0.5 ~ 0.8	0.8 ~ 1.1	0.8 ~ 1.1

WD series

■Dimensions

Cap. (μF) \ V	6.3			10			16			25			35			50		
Code	0J			1A			1C			1E			1V			1H		
1	010															4×5.8	5.00	30
2.2	2R2															4×5.8	5.00	30
3.3	3R3															4×5.8	5.00	30
4.7	4R7												4×5.8	1.80	80	5×5.8	1.52	85
10	100									4×5.8	1.80	80	5×5.8	0.76	150	6.3×5.8	0.88	165
15	150						4×5.8	1.80	80	5×5.8	0.76	150	5×5.8	0.76	150	6.3×5.8	0.88	165
22	220				4×5.8	1.80	80	5×5.8	0.76	150	5×5.8	0.76	150	5×5.8	0.76	150	6.3×5.8	0.88	165
27	270	4×5.8	1.80	80	5×5.8	0.76	150	5×5.8	0.76	150	6.3×5.8	0.44	230	6.3×5.8	0.44	230	6.3×7.7	0.68	185
33	330	5×5.8	0.76	150	5×5.8	0.76	150	6.3×5.8	0.44	230	6.3×5.8	0.44	230	6.3×5.8	0.44	230	6.3×7.7	0.68	185
47	470	5×5.8	0.76	150	6.3×5.8	0.44	230	6.3×5.8	0.44	230	6.3×5.8	0.44	230	6.3×5.8	0.44	230	6.3×7.7	0.68	185
56	560	5×5.8	0.76	150	6.3×5.8	0.44	230	6.3×5.8	0.44	230	6.3×5.8	0.44	230	6.3×7.7	0.34	280	8×10	0.34	300
68	680	6.3×5.8	0.44	230	6.3×5.8	0.44	230	6.3×5.8	0.44	230	6.3×5.8	0.44	230	6.3×7.7	0.34	280	8×10	0.34	300
100	101	6.3×5.8	0.44	230	6.3×5.8	0.44	230	6.3×5.8	0.44	230	6.3×7.7	0.34	280	8×10	0.17	450	8×10	0.34	300
150	151	6.3×5.8	0.44	230	6.3×5.8	0.44	230	6.3×7.7	0.34	280	8×10	0.17	450	8×10	0.17	450	10×10	0.18	670
220	221	6.3×5.8	0.44	230	6.3×7.7	0.34	280	6.3×7.7	0.34	280	8×10	0.17	450	10×10	0.09	670	10×10	0.18	670
330	331	6.3×7.7	0.34	280	8×10	0.17	450	8×10	0.17	450	10×10	0.09	670	10×10	0.09	670			
470	471	8×10	0.17	450	8×10	0.17	450	8×10	0.17	450	10×10	0.09	670						
680	681	8×10	0.17	450	10×10	0.09	670	10×10	0.09	670									
1000	102	10×10	0.09	670	10×10	0.09	670										Case size φD×L (mm)	Impedance	Rated ripple
1500	152	10×10	0.09	670															

Max. Impedance (Ω) at 20°C 100kHz,
Rated Ripple (mArms) at 105°C 100kHz

●Frequency coefficient of rated ripple current

Frequency	50 Hz	120 Hz	300 Hz	1 kHz	10 kHz~
Coefficient	0.35	0.50	0.64	0.83	1.00

- Taping specifications are given in page 24.
- Recommended land size, soldering by reflow are given in page 25, 26.
- Please refer to page 3 for the minimum order quantity.